

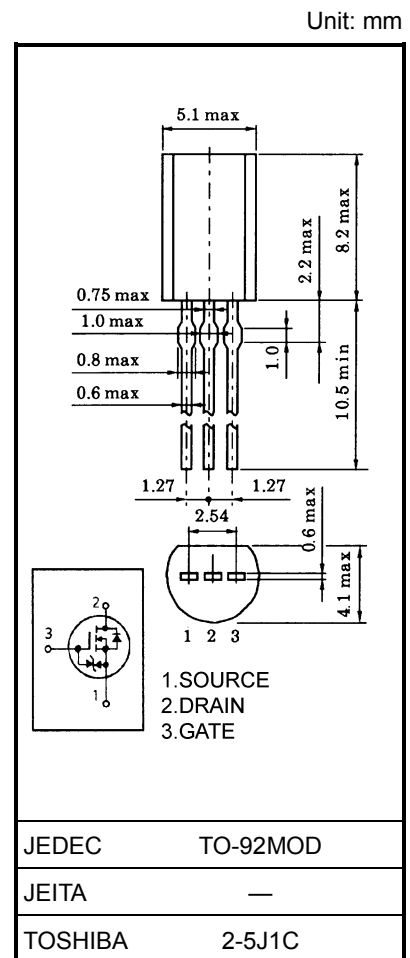
# 2SK2962

Chopper Regulator, DC-DC Converter and Motor Drive Applications

- 4 V gate drive
- Low drain-source ON resistance :  $R_{DS(ON)} = 0.5 \Omega$  (typ.)
- High forward transfer admittance :  $|Y_{fs}| = 1.2 S$  (typ.)
- Low leakage current :  $I_{DSS} = 100 \mu A$  (max) ( $V_{DS} = 100 V$ )
- Enhancement-mode :  $V_{th} = 0.8 \sim 2.0 V$  ( $V_{DS} = 10 V, I_D = 1 mA$ )

## Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		$V_{DSS}$	100	V
Drain-gate voltage ( $R_{GS} = 20 k\Omega$ )		$V_{DGR}$	100	V
Gate-source voltage		$V_{GSS}$	$\pm 20$	V
Drain current	DC (Note 1)	$I_D$	1	A
	Pulse (Note 1)	$I_{DP}$	3	A
Drain power dissipation		$P_D$	0.9	W
Single pulse avalanche energy (Note 2)		$E_{AS}$	137	mJ
Avalanche current		$I_{AR}$	1	A
Repetitive avalanche energy (Note 3)		$E_{AR}$	0.09	mJ
Channel temperature		$T_{ch}$	150	°C
Storage temperature range		$T_{stg}$	-55~150	°C



Weight: 0.36 (typ.)

## Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient	$R_{th(ch-a)}$	138	°C / W

Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2:  $V_{DD} = 25 V, T_{ch} = 25^\circ C$  (initial),  $L = 221 mH, R_G = 25 \Omega, I_{AR} = 1 A$

Note 3: Repetitive rating; Pulse width limited by maximum channel temperature.

This transistor is an electrostatic sensitive device.  
Please handle with caution.

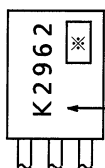
## Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		$I_{GSS}$	$V_{GS} = \pm 16\text{ V}, V_{DS} = 0\text{ V}$	—	—	$\pm 10$	$\mu\text{A}$
Drain cut-off current		$I_{DSS}$	$V_{DS} = 100\text{ V}, V_{GS} = 0\text{ V}$	—	—	100	$\mu\text{A}$
Drain-source breakdown voltage		$V_{(BR)DSS}$	$I_D = 10\text{ mA}, V_{GS} = 0\text{ V}$	100	—	—	V
Gate threshold voltage		$V_{th}$	$V_{DS} = 10\text{ V}, I_D = 1\text{ mA}$	0.8	—	2.0	V
Drain-source ON resistance		$R_{DS(ON)}$	$V_{GS} = 4\text{ V}, I_D = 0.5\text{ A}$	—	0.65	0.95	$\Omega$
			$V_{GS} = 10\text{ V}, I_D = 0.5\text{ A}$	—	0.5	0.7	
Forward transfer admittance		$ Y_{fs} $	$V_{DS} = 10\text{ V}, I_D = 0.5\text{ A}$	0.6	1.2	—	S
Input capacitance		$C_{iss}$	$V_{DS} = 10\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	—	140	—	pF
Reverse transfer capacitance		$C_{rss}$		—	20	—	
Output capacitance		$C_{oss}$		—	45	—	
Switching time	Rise time	$t_r$		—	8	—	ns
	Turn-on time	$t_{on}$		—	13	—	
	Fall time	$t_f$		—	45	—	
	Turn-off time	$t_{off}$		Duty $\leq 1\%$ , $t_w = 10\mu\text{s}$	—	175	
Total gate charge (gate-source plus gate-drain)		$Q_g$	$V_{DD} \approx 80\text{ V}, V_{GS} = 10\text{ V}, I_D = 1\text{ A}$	—	6.3	—	nC
Gate-source charge		$Q_{gs}$		—	4.3	—	
Gate-drain ("miller") Charge		$Q_{gd}$		—	2	—	

## Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Continuous drain reverse current (Note 1)	$I_{DR}$	—	—	—	1	A
Pulse drain reverse current (Note 1)	$I_{DRP}$	—	—	—	3	A
Forward voltage (diode)	$V_{DSF}$	$I_{DR} = 1\text{ A}, V_{GS} = 0\text{ V}$	—	—	-1.5	V
Reverse recovery time	$t_{rr}$	$I_{DR} = 1\text{ A}, V_{GS} = 0\text{ V}, dI_{DR}/dt = 50\text{ A}/\mu\text{s}$	—	80	—	ns
Reverse recovery charge	$Q_{rr}$		—	140	—	nC

## Marking

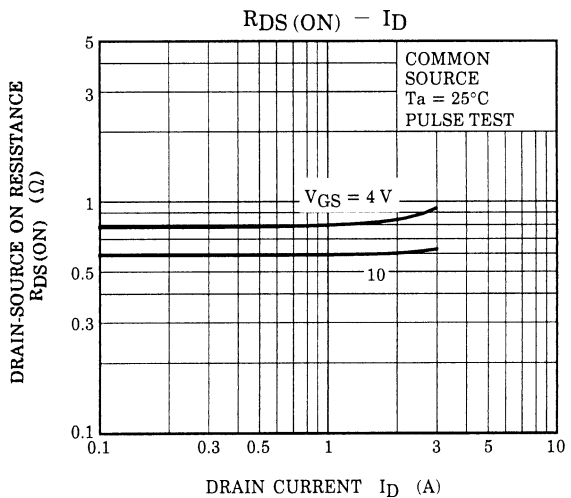
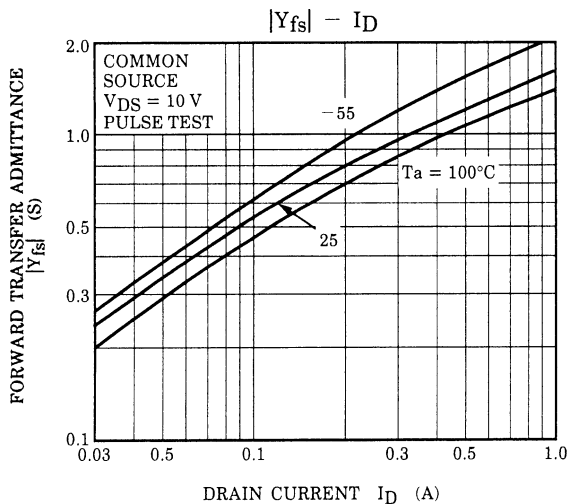
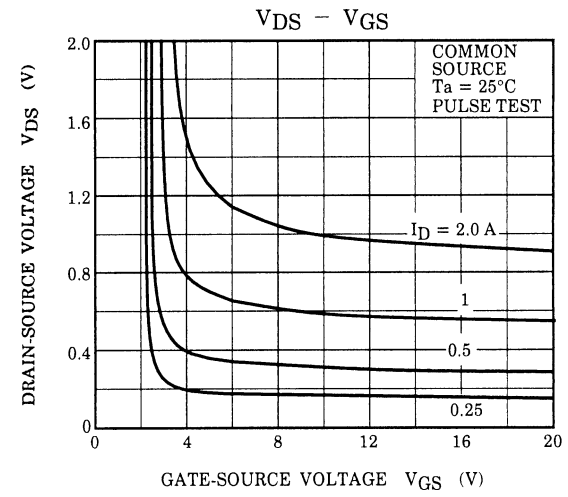
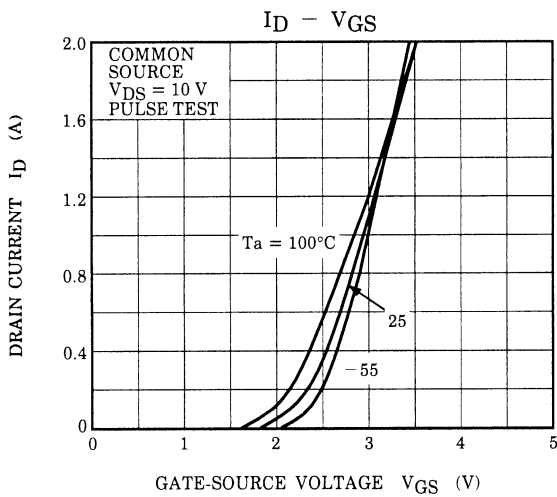
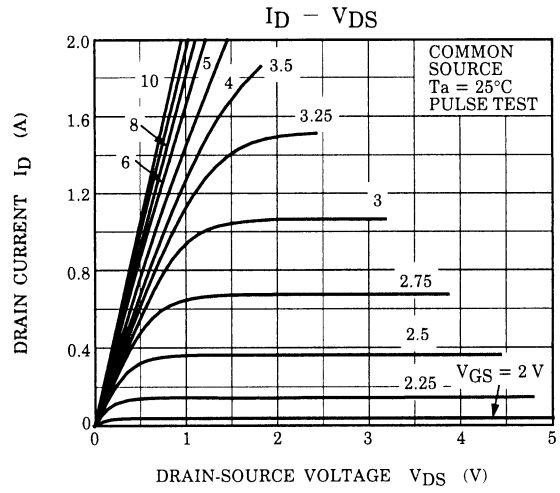
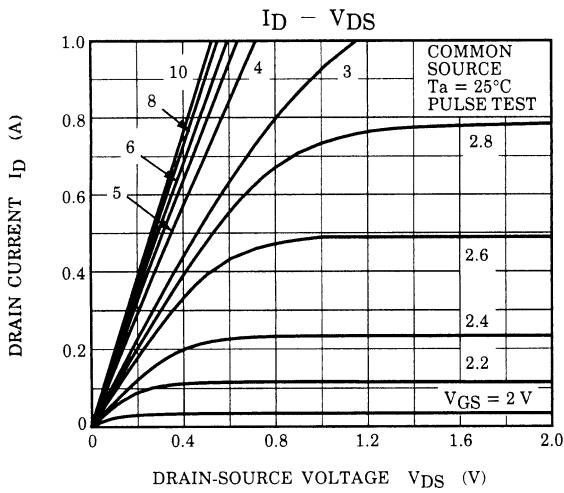


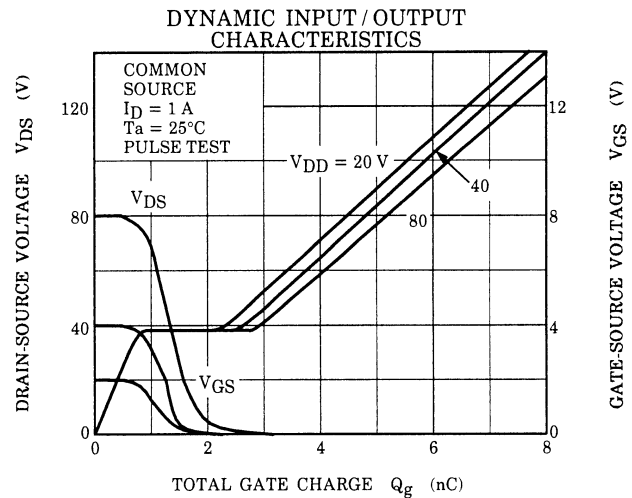
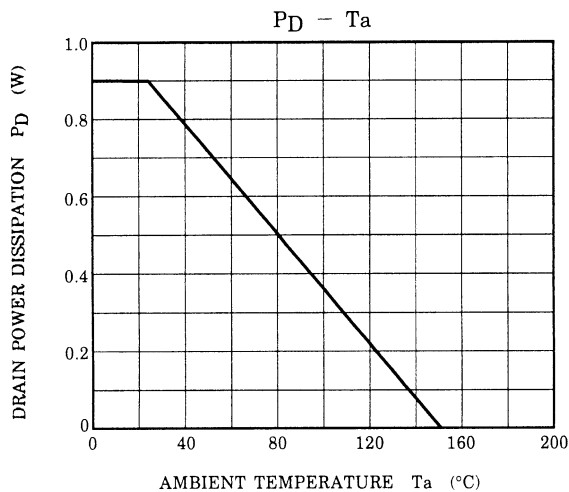
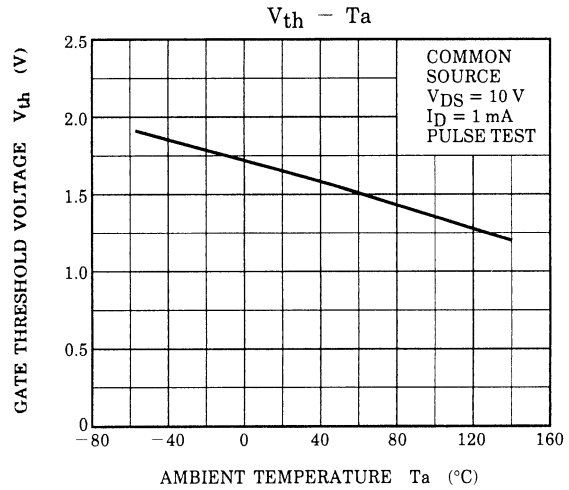
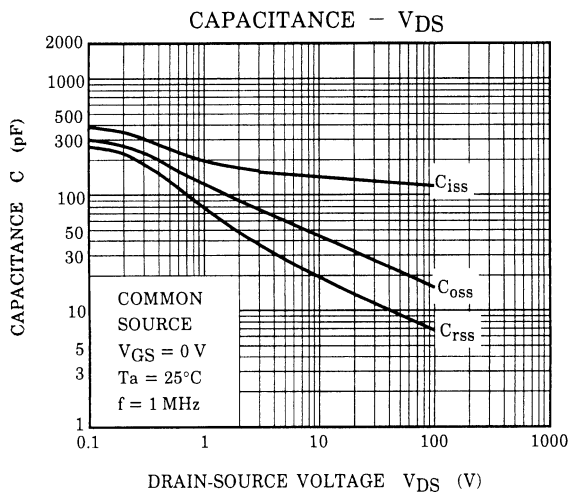
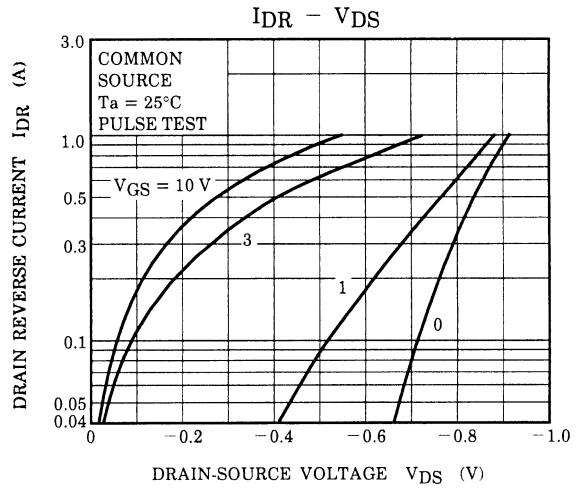
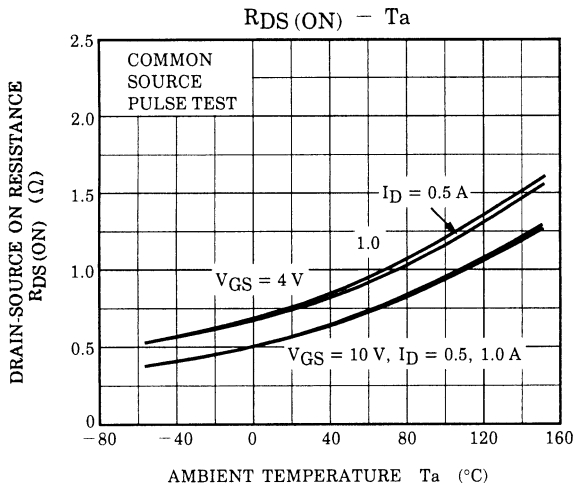
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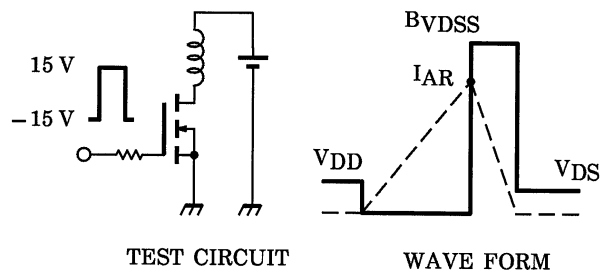
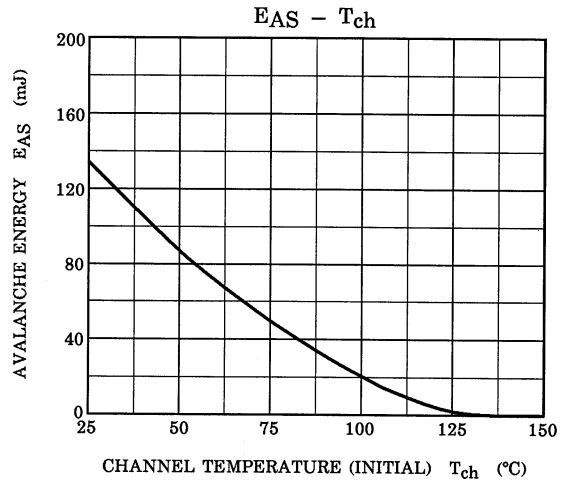
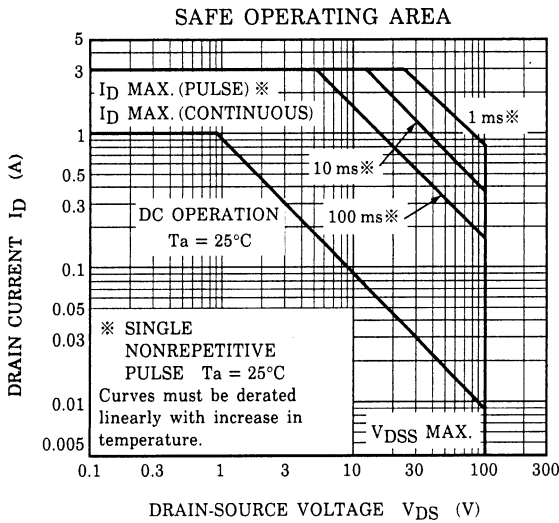
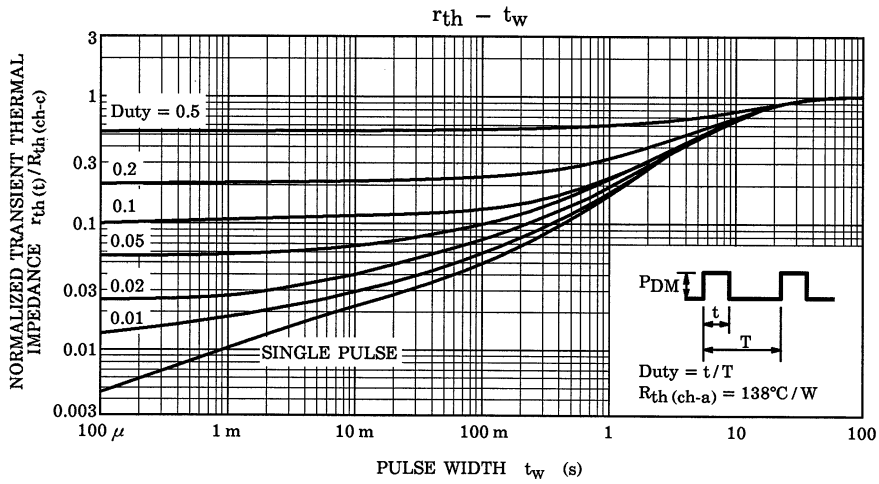
※ Lot Number

□ □ — Month (Starting from Alphabet A)

— Year (Last Number of the Christian Era)







$R_G = 25 \Omega$   
 $V_{DD} = 25 V, L = 221 mH$

$$E_{AS} = \frac{1}{2} \cdot L \cdot I^2 \cdot \left( \frac{BVDSS}{BVDSS - V_{DD}} \right)$$

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